

Material Content Data Sheet

RoHS | Halogen-Free

Sales Product Name	ISO1H811G	**Issued**	15. April 2021
MA#	MA005403922		
Package	PG-DSO-36-21	**Weight***	2105.00 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip_1	inorganic material	silicon	7440-21-3	16.733	0.79	0.79	7949	7949
chip_2	inorganic material	silicon	7440-21-3	1.164	0.06	0.06	553	553
chip_3	inorganic material	silicon	7440-21-3	1.123	0.05	0.05	533	533
leadframe	inorganic material	phosphorus	7723-14-0	0.388	0.02		184	
	non noble metal	zinc	7440-66-6	1.553	0.07		738	
	non noble metal	iron	7439-89-6	31.066	1.48		14758	
	non noble metal	copper	7440-50-8	1,261.410	59.93	61.50	599245	614925
wire	noble metal	gold	7440-57-5	4.210	0.20	0.20	2000	2000
encapsulation	organic material	carbon black	1333-86-4	1.523	0.07		723	
	plastics	epoxy resin	-	70.040	3.33		33273	
	inorganic material	silicondioxide	60676-86-0	689.740	32.77	36.17	327668	361664
leadfinish	non noble metal	tin	7440-31-5	15.044	0.71	0.71	7147	7147
plating	noble metal	silver	7440-22-4	0.644	0.03	0.03	306	306
solder	non noble metal	tin	7440-31-5	0.101			48	
	noble metal	silver	7440-22-4	0.151	0.01		72	
	non noble metal	lead	7439-92-1	9.819	0.47	0.48	4665	4785
glue	plastics	Polyimide	26023-21-2	0.290	0.01	0.01	138	138
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

Company	Infineon Technologies AG
Address	81726 Neubiberg
Internet	www.infineon.com